





Zhengzhou University

Xingyuan Shi Xuebei Ren Haobin Liu Weixing Zhang, Coach



The 46th ICPC Asia Regional Contest Shanghai Site 2021

Shanghai University, November 27-28, 2021



icpc.foundation

William B. Poucher, Ph. D.
ICPC Executive Director

Dr. C. J. Hwang
ICPC Asia Contests Council Executive Director

Professor Nie Qing, Vice President ICPC Asia Shanghai Regional Director

2021ICPC-SHU-H-2481







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Awarded to contestant

Xingyuan Shi

Zhengzhou University

Honorable Mention

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